

APPLICATION FOR UNITED STATES PATENT DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; that

I verily believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: SEMICONDUCTOR MANUFACTURING METHOD AND SEMICONDUCTOR MANUFACTURING APPARATUS

described and claimed in the specification:

Check one

- *a. ☐ attached hereto.
b. ☒ filed on _____ as Application No. _____ and amended on _____ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

Under Title 35, U.S. Code §119, the priority benefits of the following foreign application(s) and/or United States provisional application(s) filed within one year prior to this application are hereby claimed:

Japanese Patent Application No. 11-99562, filed April 7, 1999

The following application(s) for patent or inventor's certificate on this invention were filed in countries foreign to the United States of America either (a) more than one year prior to this application, or (b) before the filing date of the above-named foreign priority application(s) and/or United States provisional application(s):

I hereby appoint the following as my attorneys of record with full power of substitution and revocation to prosecute this application and to transact all business in the Patent Office:

James A. Oliff, Reg. No. 27,075; William P. Berridge, Reg. No. 30,024;
Kirk M. Hudson, Reg. No. 27,562; Thomas J. Pardini, Reg. No. 30,411;
Edward P. Walker, Reg. No. 31,450; Robert A. Miller, Reg. No. 32,771;
Mario A. Costantino, Reg. No. 33,565; and Caroline D. Dennison, Reg. No. 34,494.

ALL CORRESPONDENCE IN CONNECTION WITH THIS APPLICATION SHOULD BE SENT TO OLIFF & BERRIDGE, PLC, P.O. BOX 19928, ALEXANDRIA, VIRGINIA 22320, TELEPHONE (703) 836-6400.

I hereby declare that I have reviewed and understand the contents of this Declaration, and that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

1 **Typewritten Full Name
of First or Sole Inventor**

Akihiro

OSAKA

Given Name

Middle Initial

Family Name

2 ****Inventor's Signature:**

Akihiro

OSAKA

3 ****Date of Signature:**

April

17

2000

Month

Day

Year

Residence:

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Japan

City

State or Province

Country

Citizenship:

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mailing address,
including country)

C/O KOKUSAI ELECTRIC CO., LTD.

14-20, 3-chome, Higashi-Nakano, Nakano-ku, TOKYO 164-8511, JAPAN

*If Box (a.) is checked, this form may be executed only when attached to the specification (including claims).

**Note to Inventor: Please sign name exactly as it appears above and insert actual date of signing.

IF THERE IS MORE THAN ONE INVENTOR USE PAGE 2 AND PLACE AN "X" HERE ☒

PAGE 2 OF U.S.A. DECLARATION FORM
(Do not fill in this page in a sole inventor application)

1 **Typewritten Full Name**
of Second Joint Inventor (if any)

Hiroshi	SEKIYAMA
Given Name	Family Name

2 ****Inventor's Signature:**

Hiroshi Sekiyama

3 ****Date of Signature:**

<u>April</u>	<u>18</u>	<u>2000</u>
Month	Day	Year

Residence:

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1 **Typewritten Full Name**
of Third Joint Inventor (if any)

Kouichi	NOTO
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2 ****Inventor's Signature:**

Kouichi Noto

3 ****Date of Signature:**

<u>April</u>	<u>18</u>	<u>2000</u>
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1 **Typewritten Full Name**
of Fourth Joint Inventor (if any)

Masaki	SUGAWARA
Given Name	Family Name

2 ****Inventor's Signature:**

Masaki SUGAWARA

3 ****Date of Signature:**

<u>April</u>	<u>17</u>	<u>2000</u>
Month	Day	Year

Residence:

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1 **Typewritten Full Name**
of Fifth Joint Inventor (if any)

Given Name	Middle Initial	Family Name
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2 ****Inventor's Signature:**

3 ****Date of Signature:**

____	____	____
Month	Day	Year

Residence:

City

State or Province

Country

Citizenship:

Post Office Address:

(Insert complete
mailing address,
including country)

****Note to Inventors: Please sign name exactly as it appears and insert the actual date of signing.**

This form may be executed only when attached to the first page of the Declaration and Power of Attorney form of the application to which it pertains.

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